



# GBU4005 THRU GBU410

PINGWEI ENTERPRISE

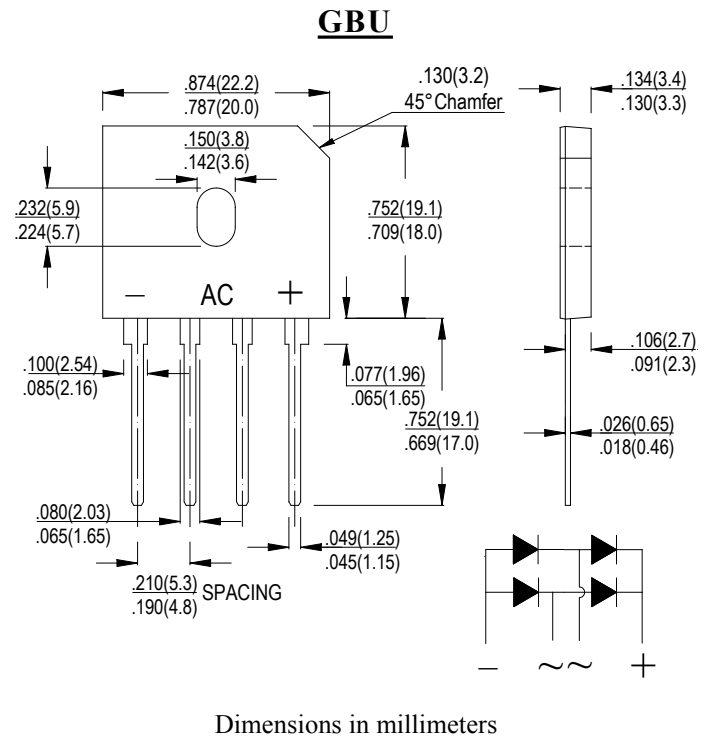
## SINGLE PHASE 4.0 AMPS. GLASS PASSIVATED BRIDGE RECTIFIERS

### FEATURE

- . UL Recognized File # E338195
- . Ideal for printed circuit board
- . Glass passivated chip junctions
- . High case dielectric strength
- . Low leakage
- . Low forward voltage
- . High surge current capability
- . High temperature soldering guaranteed:  
260°C/10seconds/.375"(9.5mm) lead lengths.

### MECHANICAL DATA

- . Case: Molded plastic body
- . Epoxy: UL 94V-0 rate flame retardant
- . Terminals: Pure tin plated, Lead free. Leads solderable per MIL-STD-750, Method 2026.
- . Polarity: Symbols molded or marked on body
- . Mounting position: Any
- . Weight: 8.0 grams



Dimensions in millimeters

### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number	SYMBOL	GBU 4005	GBU 401	GBU 402	GBU 404	GBU 406	GBU 408	GBU 410	units	
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V	
Maximum RMS Voltage	$V_{RMS}$	35	70	140	280	420	560	700	V	
Maximum DC blocking Voltage	$V_{DC}$	50	100	200	400	600	800	1000	V	
Maximum Average Forward rectified Output Current at $T_C=100^\circ\text{C}$	$I_{F(AV)}$	4.0							A	
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rate load (JEDEC method)	$I_{FSM}$	120							A	
Maximum Forward Voltage Drop per element at 4.0A DC	$V_F$	1.1							V	
Maximum DC Reverse Current at rated DC blocking voltage	$I_R$	@ $T_A=25^\circ\text{C}$	10.0							$\mu\text{A}$
		@ $T_A=125^\circ\text{C}$	500.0							
$I^2t$ Rating for Fusing ( $t < 8.3\text{ms}$ )	$I^2t$	59.7							$\text{A}^2\text{s}$	
Typical Junction Capacitance (Note 1)	$C_J$	40							pF	
Typical Thermal Resistance (Note 2)	$R_{(JC)}$	2.2							$^\circ\text{C}/\text{W}$	
Storage Temperature	$T_{STG}$	-55 to +150							$^\circ\text{C}$	
Operating Junction Temperature	$T_J$	-55 to +150							$^\circ\text{C}$	

#### Note:

1. Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc
2. Thermal Resistance from Junction to Case Mounted on P.C.B with 0.47×0.47"(12×12mm) Copper Pads.